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MICROWAVE CORPORATION v05.1213



HMC311LP3 / 311LP3E

InGaP HBT GAIN BLOCK MMIC AMPLIFIER, DC - 6 GHz

Typical Applications

The HMC311LP3(E) is ideal for:

- Cellular / PCS / 3G
- Fixed Wireless & WLAN
- CATV & Cable Modem
- Microwave Radio

Features

P1dB Output Power: +15.5 dBm

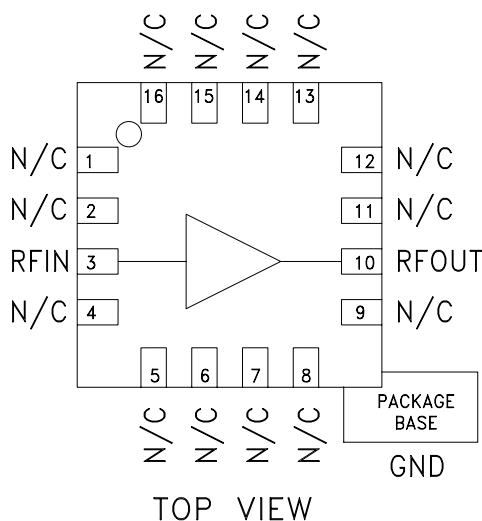
Output IP3: +32 dBm

Gain: 14.5 dB

50 Ohm I/O's

16 Lead 3x3mm SMT Package: 9mm²

Functional Diagram



General Description

The HMC311LP3(E) is a GaAs InGaP Heterojunction Bipolar Transistor (HBT) Gain Block MMIC SMT DC to 6 GHz amplifiers. This 3x3mm QFN packaged amplifier can be used as either a cascadable 50 Ohm gain stage or to drive the LO of HMC mixers with up to +17 dBm output power. The HMC311LP3(E) offers 14.5 dB of gain and an output IP3 of +32 dBm while requiring only 56 mA from a +5V supply. The Darlington feedback pair used results in reduced sensitivity to normal process variations and yields excellent gain stability over temperature while requiring a minimal number of external bias components.

Electrical Specifications, $V_s = 5V$, $R_{bias} = 22\ \Omega$, $T_A = +25^\circ\text{C}$

Parameter		Min.	Typ.	Max.	Units
Gain	DC - 1.0 GHz	13.0	14.5		dB
	1.0 - 4.0 GHz	12.5	14.3		dB
	4.0 - 6.0 GHz	12.0	14.0		dB
Gain Variation Over Temperature	DC - 2.0 GHz		0.005	0.008	dB/ °C
	2.0 - 4.0 GHz		0.008	0.012	dB/ °C
	4.0 - 6.0 GHz		0.012	0.016	dB/ °C
Return Loss Input / Output	DC - 1.0 GHz		13		dB
	1.0 - 3.0 GHz		11		dB
	3.0 - 6.0 GHz		15		dB
Reverse Isolation	DC - 6 GHz		18		dB
Output Power for 1 dB Compression (P1dB)	DC - 2.0 GHz	13.5	15.5		dBm
	2.0 - 4.0 GHz	12.0	15.0		dBm
	4.0 - 6.0 GHz	10.0	13.0		dBm
Output Third Order Intercept (IP3)	DC - 1.0 GHz		32		dBm
	1.0 - 2.0 GHz		30		dBm
	2.0 - 4.0 GHz		28		dBm
	4.0 - 6.0 GHz		24		dBm
Noise Figure	DC - 6 GHz		4.5		dB
Supply Current (Icq)			55	74	mA

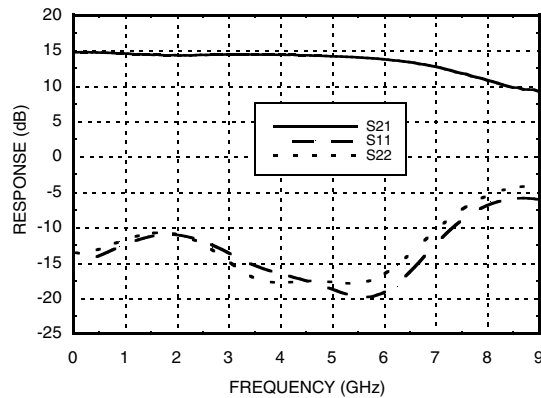
Note: Data taken with broadband bias tee on device output.

For price, delivery and to place orders: Hittite Microwave Corporation, 2 Elizabeth Drive, Chelmsford, MA 01824

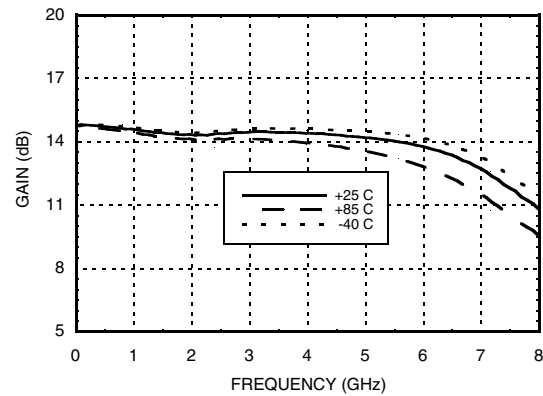
Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com

Application Support: Phone: 978-250-3343 or apps@hittite.com

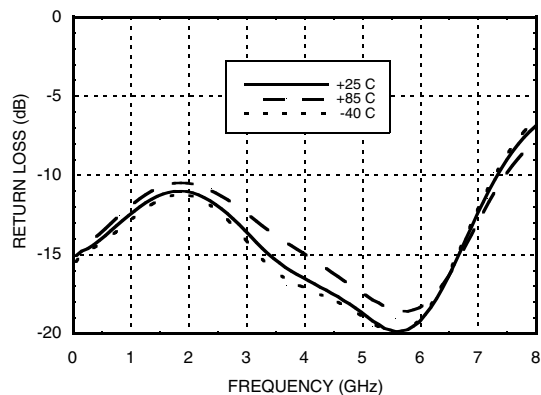
Gain & Return Loss



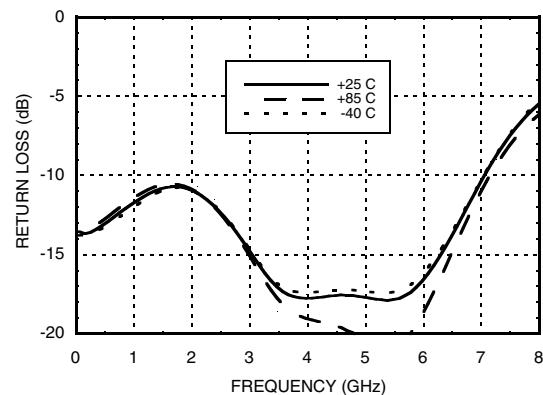
Gain vs. Temperature



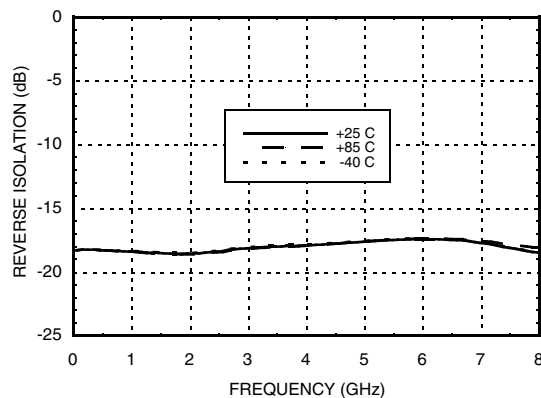
Input Return Loss vs. Temperature



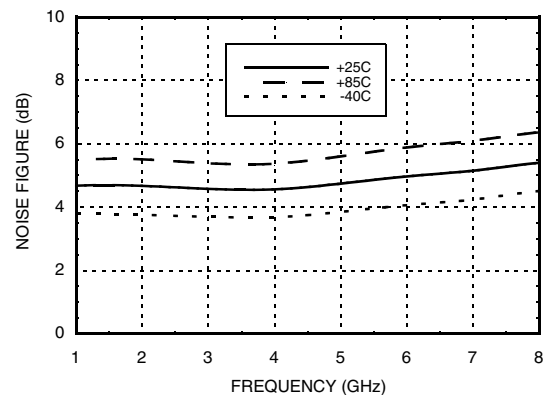
Output Return Loss vs. Temperature



Reverse Isolation vs. Temperature



Noise Figure vs. Temperature





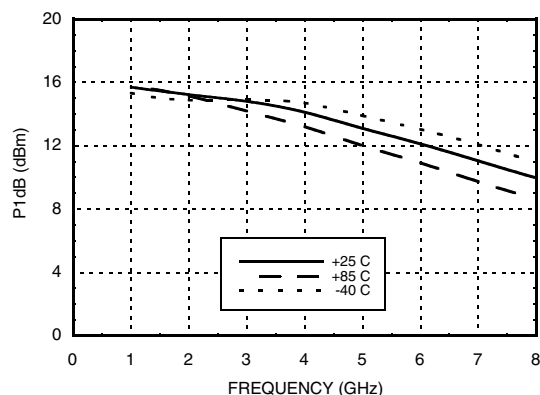
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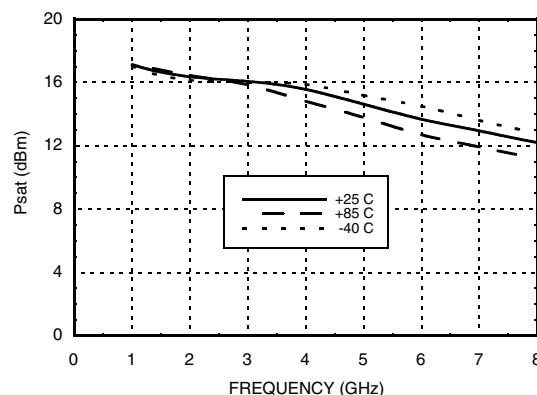
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MMIC AMPLIFIER, DC - 6 GHz

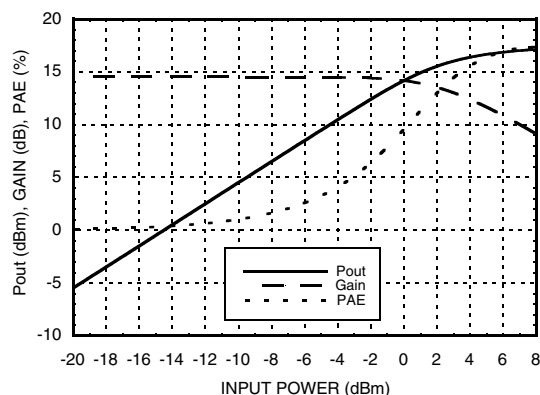
P1dB vs. Temperature



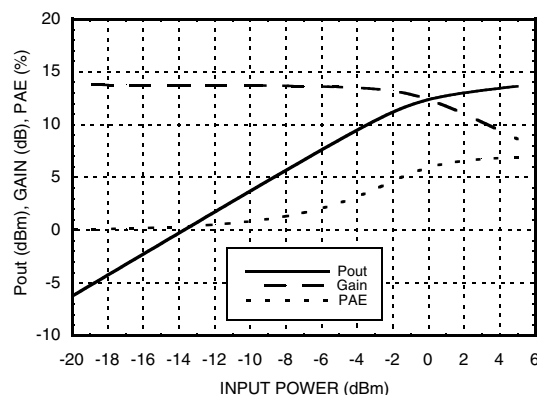
Psat vs. Temperature



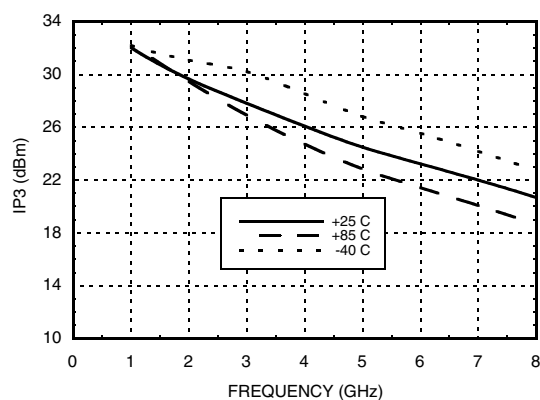
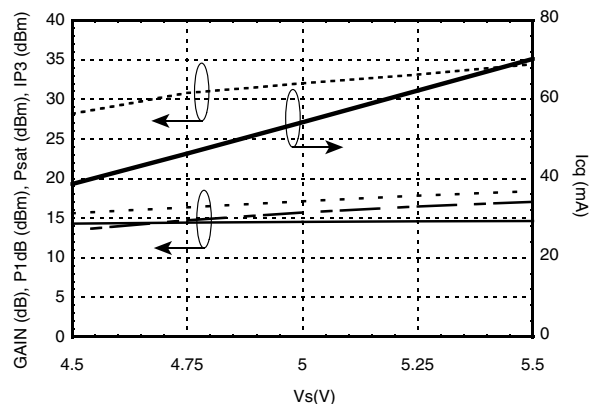
Power Compression @ 1 GHz



Power Compression @ 6 GHz



Output IP3 vs. Temperature

Gain, Power, Output IP3 & Supply Current
vs. Supply Voltage @ 1 GHz

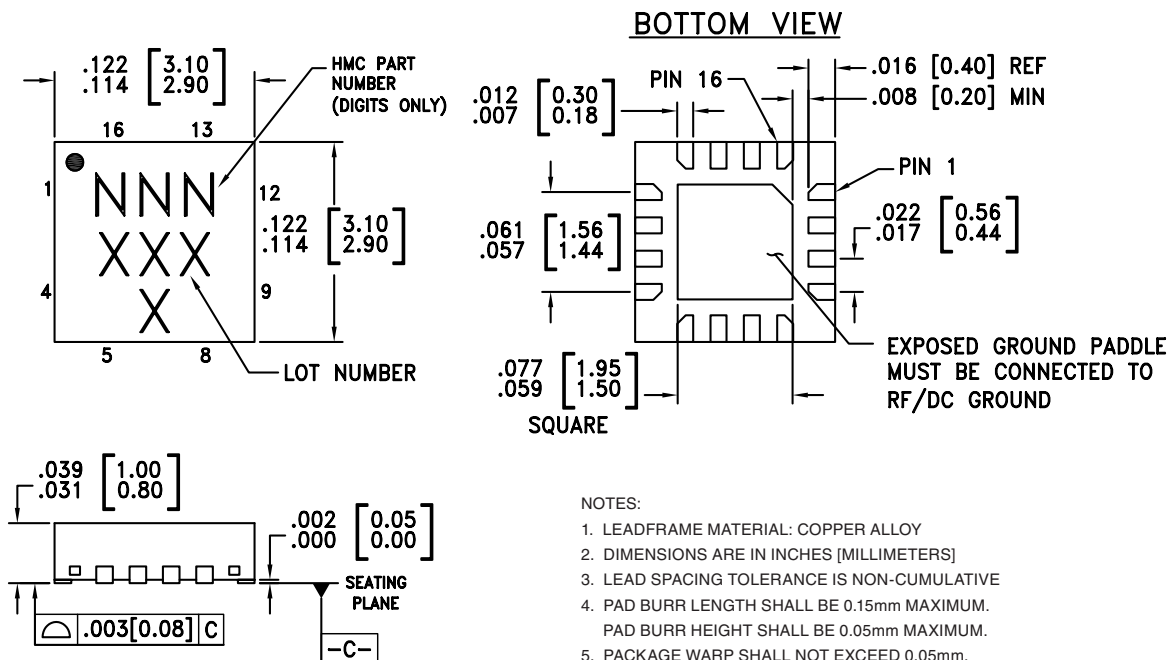
Absolute Maximum Ratings

Collector Bias Voltage (Vcc)	+7V
RF Input Power (RFIN)(Vs = +5V)	+10 dBm
Junction Temperature	150 °C
Continuous P _{diss} (T = 85 °C) (derate 5.21 mW/°C above 85 °C)	0.339 W
Thermal Resistance (junction to ground paddle)	192 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A



ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Outline Drawing



Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[3]
HMC311LP3	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 ^[1]	311 XXXX
HMC311LP3E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	311 XXXX

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX



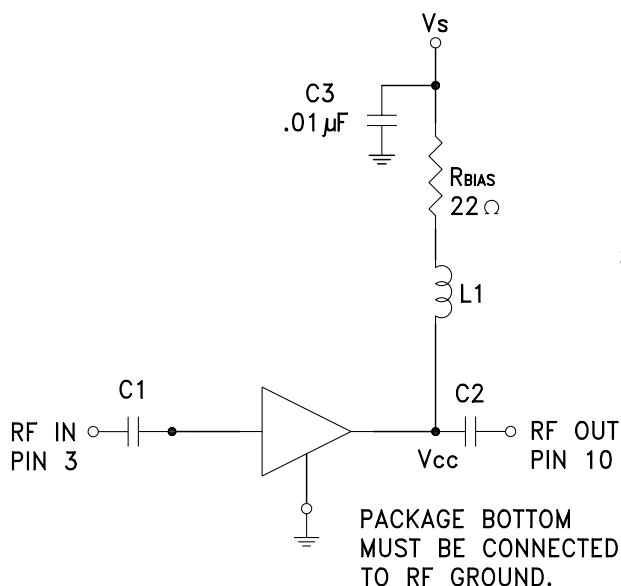
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**HMC311LP3 / 311LP3E**

**InGaP HBT GAIN BLOCK
MMIC AMPLIFIER, DC - 6 GHz**

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 2, 4 - 9, 11 - 16	N/C	This pin may be connected to RF ground.	
3	RFIN	This pin is DC coupled. An off chip DC blocking capacitor is required.	
10	RFOUT	RF output and DC Bias for the output stage.	
	GND	Package bottom must be connected to RF/DC ground.	

Application Circuit

Note:

1. Select Rbias to achieve Icq using equation below, $R_{bias} \geq 22 \text{ Ohm}$.
2. External blocking capacitors are required on RFIN and RFOUT.

$$I_{cq} = \frac{V_s - 3.8}{R_{bias}}$$

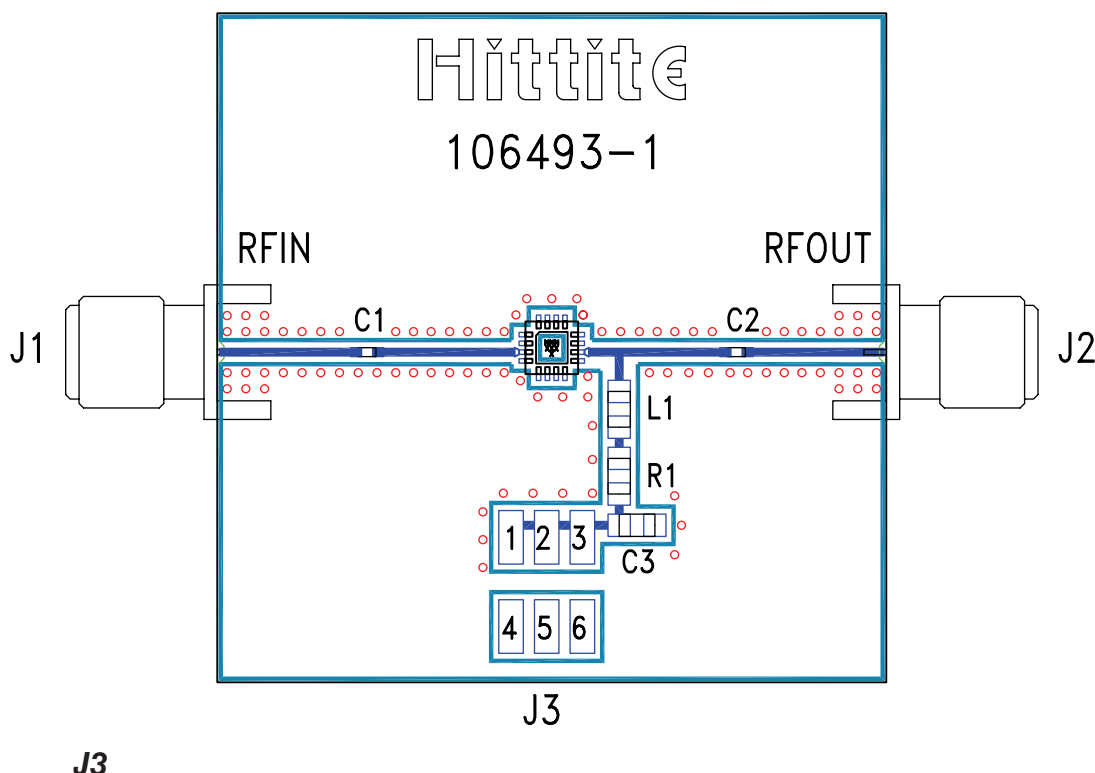
Recommended Component Values

Component	Frequency (MHz)							
	50	900	1900	2200	2400	3500	5200	5800
L1	270 nH	56 nH	18 nH	18 nH	15 nH	8.2 nH	3.3 nH	3.3 nH
C1, C2	0.01 μF	100 pF	100 pF	100 pF	100 pF	100 pF	100 pF	100 pF

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Application Support: Phone: 978-250-3343 or apps@hittite.com

Evaluation PCB


Pin Number	Description
1, 2, 3	Vs
4, 5, 6	GND

List of Materials for Evaluation PCB 106789 ^[1]

Item	Description
J1 - J2	PC Mount SMA Connector
J3	2 mm DC Header
C1, C2	Capacitor, 0402 Pkg.
C3	10,000 pF Capacitor, 0805 Pkg.
R1	22 Ohm Resistor, 0805 Pkg.
L1	Inductor, 0805 Pkg.
U1	HMC311LP3 / HMC311LP3E
PCB ^[2]	106493 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

Mouser Electronics

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